MAMXSS0013



Low Cost MMIC Mixer 1400 - 2100 MHz

Rev. V3

Features

- +12 dBm Input Power @ 1 dB Compression
- · High Isolation, 28 dB LO to RF
- +3 to +8 dBm LO Drive Level
- DC 500 MHz 3 dB IF Bandwidth
- · Does not require DC bias
- Lead-Free SOT-25 Package
- 100% Matte Tin Plating over Copper
- Halogen-Free "Green" Mold Compound
- 260°C Reflow Compatible
- RoHS* Compliant Version of MD54-0006

Description

M/A-COM's MAMXSS0013 is a passive mixer that achieves the performance of a double balanced diode mixer in a lead-free SOT-25 package. The MAMXSS0013 is ideally suited for use where high level RF signals and very wide dynamic range are required. Typical applications include frequency up/down conversion, modulation and demodulation in receivers and transmitters for base station and portable systems.

The MAMXSS0013 uses FETs as mixing elements to achieve very wide dynamic range in a low cost plastic package. The mixer operates with LO drive levels of +3 dBm to +8 dBm. The LO port may be externally tuned for operation in various frequency bands.

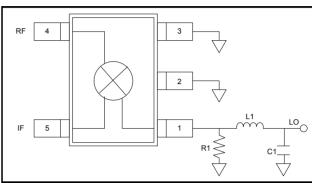
M/A-COM's MAMXSS0013 is fabricated using a mature 0.5 micron gate length GaAs MESFET process. The process features full passivation for increased performance and reliability. The MAMXSS0013 is 100% RF tested to ensure performance specification compliance.

Ordering Information¹

Part Number	Package		
MAMXSS0013	Bulk Packaging		
MAMXSS0013TR-3000	3000 piece reel		
MAMX-000013-001SMB	Sample Board 1500 MHz		
MAMX-000013-002SMB	Sample Board 1710 MHz		
MAMX-000013-003SMB	Sample Board 2300 MHz		

1. Reference Application Note M513 for reel size information.

Functional Block Diagram



Pin Configuration

Pin No.	Pin Name	ame Description		
1	LO Port LO Input			
2	Ground	Ground		
3	Ground	Ground		
4	RF Port	RF Input		
5	IF Port	IF Output		

External Circuitry Parts List ^{2,3}

LO Frequency					
Part	1500 MHz	1710 MHz	2300 MHz		
R1	470 Ω	470 Ω	820 Ω		
L1	6.8 nH	4.7 nH	2.7 nH		
C1	3.3 pF	2.2 pF	2.2 pF		

- The external LO matching network allows tuning from 1400 MHz to 2300 MHz. The networks given above are intended to serve as guidelines for matching in different bands.
- All off-chip components are low-cost surface mount components obtainable from multiple sources (0.060 in. x 0.030 in. or 0.080 in. x 0.050 in).

* Restrictions on Hazardous Substances, European Union Directive 2002/95/EC.

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Electrical Specifications⁴:

RF = 1850 MHz (-10 dBm), LO = 1710 MHz (+5 dBm), IF = 140 MHz, $T_A = 25$ °C

Parameter	Test Conditions	Units	Min.	Тур.	Max.
Conversion Loss		dB	-	8.0	9.0
Isolation	LO to RF LO to IF RF to IF	dB dB dB	_ _ _	28 15 15	_
VSWR	RF Port LO Port ³ IF Port	Ratio Ratio Ratio	_ _ _	2.0:1 2.0:1 2.0:1	_
Input 1 dB Compression	LO = +5 dBm, RF Freq: 1850 MHz	dBm	_	12	_
Two-Tone IM Ratio ⁵ Two Tones at -10 dBm each, Tone spacing = 100 KHz, IF = 140 MHz		dBc	_	55	_

^{4.} With external LO Port matching. See functional block diagram.

Absolute Maximum Ratings 6,7

Parameter	Absolute Maximum		
RF Input Power	+27 dBm		
LO Drive Power	+27 dBm		
Operating Temperature	-40°C to +85°C		
Storage Temperature	-65°C to +150°C		

^{6.} Exceeding any one or combination of these limits may cause permanent damage to this device.

Spurious Table

	4x	38.3 27.3	39.9	52.5	77.1	78.7
O.	3x	21.4 10.5	30.1 30.1	69.0 70.5	43.0 58.8	68.3 76.8
of LO	2x	9.0 -0.9	36.1 36.4	36.0 45.8	65.8 75.0	64.3 78.0
Harmonic	1x	1.9 -6.0	0	44.8 55.5	56.1 75.2	65.0 78.3
Harn	0x	X	8.1 8.3	45.5 54.4	56.8 72.3	72.9 74.3
		0x	1x	2x	3x	4x
			_	ic of RF		

The spurious table shows the spurious signals resulting from the mixing of the RF and LO input signals, assuming down conversion. Mixing products are indicated relative to the IF. The lower frequency mixing term is shown for two different RF input levels. The top number is for an RF input power of 0 dBm, the lower number is for -10 dBm.

 $|nF_{RF} - mF_{LO}|$, RF = 0 dBm $|nF_{RF} - mF_{LO}|$, RF = -10 dBm RF Frequency = 1850 MHz LO Frequency = 1710 MHz

^{5.} IMR vs. RF drive can be calculated by the formula: IMR = 40-1.5*Pin.

M/A-COM does not recommend sustained operation near these survivability limits.

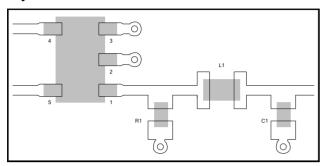


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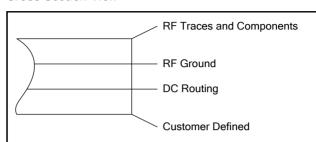
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Recommended PCB Configuration

Layout View

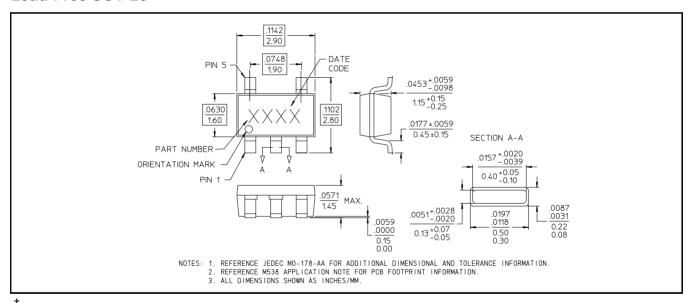


Cross Section View



The PCB dielectric between RF traces and RF ground layers should be chosen to reduce RF discontinuities between 50 Ω lines and package pins. M/A-COM recommends an FR-4 dielectric thickness of 0.008" (0.2 mm) yielding a 50 Ω line width of 0.015" (0.38). The recommended metalization is 1 ounce copper.

Lead-Free SOT-25[†]



Reference Application Note M538 for lead-free solder reflow recommendations. Meets JEDEC moisture sensitivity level 1 requirements.



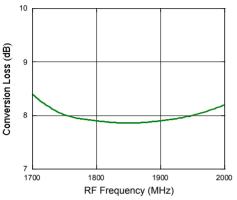
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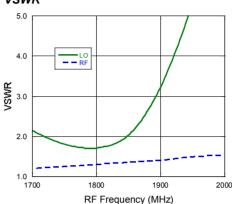
Typical Performance Curves

- Test Conditions for Down Converter Application: RF = 1850 MHz (-10 dBm), IF = 140 MHz, LO = 1710 MHz (+5 dBm).
- Test Conditions for Up Converter Application: LO = 1710 MHz (+5 dBm), IF = 140 MHz (-10 dBm), RF = 1850 MHz.

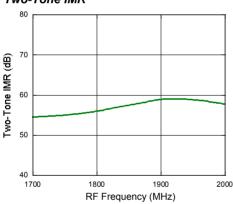
Conversion Loss (Up/Down)



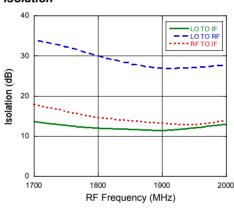
VSWR



Two-Tone IMR



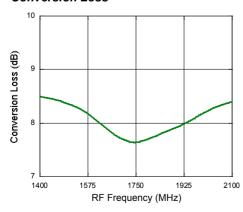
Isolation



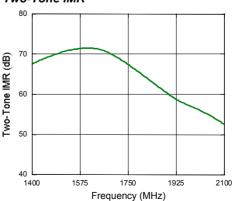
Wide-

• Test Conditions for Wide-Band Application: RF = -10 dBm, IF = 140 MHz, LO = +11 dBm, LO Port resistively matched. Lower LO drive operation is available for narrow band performance using external reactive matching. The 3 dB IF bandwidth is 500 MHz. IF frequencies above 200 MHz can be optimized for low conversion loss by using external matching components.

Conversion Loss



Two-Tone IMR



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